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Low-Temperature Plasma-Assisted Atomic-Layer-Deposited SnO₂ as an Electron Transport Layer in Planar Perovskite Solar Cells

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Supporting Information

ABSTRACT: In this work, we present an extensive characterization of plasma-assisted atomic-layer-deposited SnO₂ layers, with the aim of identifying key material properties of SnO₂ to serve as an efficient electron transport layer in perovskite solar cells (PSCs). Electrically resistive SnO₂ films are fabricated at 50 °C, while a SnO₂ film with a low electrical resistivity of 1.8 × 10⁻³ Ω cm, a carrier density of 9.6 × 10¹⁷ cm⁻³, and a high mobility of 36.0 cm²/V s is deposited at 200 °C. Ultraviolet photoelectron spectroscopy indicates a conduction band offset of ∼0.69 eV at the 50 °C SnO₂/Cs₀.₀⁵(MA₀.₁₇FA₀.₈₃)₀.₉₅Pb⁻(I₂.Br⁻)₀ interface. In contrast, a negligible conduction band offset is found between the 200 °C SnO₂ and the perovskite. Surprisingly, comparable initial power conversion efficiencies (PCEs) of 17.5% and 17.8% are demonstrated for the champion cells using 15 nm thick SnO₂ deposited at 50 and 200 °C, respectively. The latter gains in fill factor but loses in open-circuit voltage. Markedly, PSCs using the 200 °C compact SnO₂ retain their initial performance at the maximum power point over 16 h under continuous one-sun illumination in inert atmosphere. Instead, the cell with the 50 °C SnO₂ shows a decrease in PCE of approximately 50%.

KEYWORDS: tin oxide, atomic layer deposition, perovskite solar cells, stability, interface, inorganic electron transport layer

1. INTRODUCTION

Over a relatively short development period of about eight years, the initial efficiency of perovskite solar cells (PSCs) has rocketed from 3.8% in 2009 up to a record efficiency of 23.3% at a laboratory scale in 2018.∞–² This high energy conversion efficiency combined with a potentially low fabrication cost makes this technology highly promising for future photovoltaic (PV) electricity generation applications.∞ Methylvammonium (CH₃NH₃⁺, MA) lead tri-iodide (MAPbI₃) is extensively adopted as photo-absorber in PSCs. Despite the impressive initial performance, critical issues remain which hamper the industrial application of this material. Among these, environmental instability due to decomposition in contact with moisture,∞–⁸ thermal instability due to the structural transition and volatile nature of the decomposed components at elevated temperatures,⁹–¹³ and light instability due to ion migration upon illumination¹⁶–¹⁸ are the main concerns. Enormous efforts are presently being made to overcome these intrinsic challenges. One of the most successful strategies so far is the change of the perovskite chemical composition to a mixed-cation lead-halide formula. For instance, the MA cation can be partially substituted by formamidinium (FA, CH₃(NH₂)⁺) to form a MA/FA dual cation perovskite. Furthermore, cesium (Cs)¹⁴ and rubidium ions (Rb⁺)²⁰ can contribute to the synthesis of Cs/MA/FA triple and Rb/ Cs/MA/FA quadruple cation perovskites. As for the mixed halide anions, bromide is typically introduced to form mixed anions I⁻/Br⁻. In this way, stability has been enhanced. Furthermore, the increased optical band gap makes it a promising top cell candidate in a tandem device for better exploitation of the solar spectrum.

To achieve an efficient electron collection in PSCs, the electron transport layer (ETL) is of crucial importance. General requirements for ETLs are considered to include the following: (1) a negligible conduction band offset with perovskites for fast electron extraction and, simultaneously, a sufficiently large valence band (VB) offset for hole blocking at the ETL/perovskite interface; (2) a pin-hole-free structure to avoid shunts due to direct contact between perovskites and electrodes; (3) a high electron mobility for fast charge redistribution of the article, and creation of adaptations, all for non-commercial purposes. © 2018 American Chemical Society

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transport and a good electrical conductivity for minimal series resistance; and (4) excellent optical transparency. Titanium dioxide (TiO₂) has traditionally been employed as the ETL for MAPbI₃ PSCs, as PSCs historically evolved from dye-sensitized solar cells. However, TiO₂ suffers from UV instability upon AM1.5 illumination. In addition, it has been reported in several works that TiO₂ thin films possess an unfavorable conduction band minimum (CBM) alignment with mixed cation perovskites, which consequently hinders an efficient electron extraction at the TiO₂/perovskite interface. In contrast to TiO₂, SnO₂ is characterized by a deeper CBM and valence band maximum (VBM), compatible with the aim of an efficient electron extraction while blocking hole transport. Besides the favorable energy levels, SnO₂ possesses a larger optical band gap in the range of 3.6–4.4 eV. These excellent optoelectronic properties make SnO₂ a promising electron transport material, particularly for mixed cation PSCs.

Despite these remarkable optoelectronic advantages, SnO₂ has only very recently been applied as the ETL for PSCs. In these early works, solution-based processes have typically been employed to fabricate mesoporous SnO₂ films, followed by thermal annealing. Atomic layer deposition (ALD), on the other hand, can deliver high-quality pin-hole-free metal oxides even at low substrate temperatures. The thickness can be accurately controlled at the ångström level because of self-limiting surface reaction mechanisms. ALD processes for the synthesis of SnO₂ films have previously been reported using halogenated precursors SnCl₄ and SnI₄. The corrosive precursors and the HCl byproduct, the relatively high deposition temperature of typically >300 °C, and the relatively low growth per cycle (GPC) are the main concerns limiting the applications of these precursors. In this regard, a halogen-free precursor, tetrakis(dimethylamino)tin (TDMAStn), for atomic-layer-deposited SnO₂ was first investigated by Elam et al. H₂O₂, H₂O, and O₂ were tested as the oxidation sources. Following that work, H₂O₂, H₂O vapor, and O₃ have been used as co-reactants. More recently, O₂ plasma-assisted ALD of SnO₂ has also been reported. The use of O₂ plasma reactant allows for low temperatures for SnO₂ thin-film deposition.

Atomic-layer-deposited SnO₂ layers have recently been implemented as ETLs in PSCs, contributing to notably high solar cell performance.

## 2. EXPERIMENTAL SECTION

### 2.1. Plasma-Assisted Atomic Layer Deposition of SnO₂

SnO₂ thin films were deposited at substrate temperatures of 50, 100, 150, and 200 °C on Czochralski polished c-Si (100) wafers and indium tin oxide (ITO) glass substrates in an Oxford Instruments Opal ALD reactor using tetraakis(dimethylamino)tin (TDMAStn) (99% purity, Strem Inc.) as the tin precursor and radio-frequency (RF) inductively coupled oxygen plasma as the co-reactant. The precursor bubbler was heated to 45 °C. Argon gas at a flow rate of 100 sccm was used as the carrier gas. The ALD process consists of a TDMAStn dose of 2 s and subsequently a purge of 10 s, followed by an O₂ plasma exposure of 10 s and a purge of 5 s. Schematics for the ALD reactor and for the ALD process are shown in Figure S1. An RF power of 300 W and a pressure of 100 ± 5 mTorr (∼13 Pa) were used for the O₂ plasma. Prior to the SnO₂ depositions, the c-Si and the ITO glass substrates were cleaned by O₂ plasma for 3 min in the same ALD reactor using the same plasma settings used for the film deposition. GPC of 1.5, 1.2, 1.3, and 1.4 Å were determined by in situ spectroscopic ellipsometry (SE) for the films grown on c-Si at deposition temperatures of 50, 100, 150, and 200 °C, respectively (see Figure S2 in the Supporting Information).

### 2.2. Solar Cell Fabrication Procedure

For solar cell fabrication, soda-lime glass slides coated with ~115 nm thick InₓOᵧ/Sn (ITO) layers (sheet resistance: ~16 Ω/□) were used as substrates and ultrasonically cleaned for 5 min in a sequence of detergent (Extran MA01), deionized water, and isopropanol. SnO₂ layers were deposited at 50 or 200 °C. Shortly before perovskite deposition, the SnO₂ layers were pretreated with O₂ plasma for 2.5 min at room temperature, using an RF power of 600 W and a pressure of ~1 mbar. Triple cation perovskite layers were fabricated following a recipe reported elsewhere. Briefly, a precursor solution was prepared by dissolving HC(NH₂)₂I (FAI, 1 M, Greatcell Solar), PbI₂ (0.25 M, TCI), CH₃NH₃Br (MABr, 0.2 M, Greatcell Solar), and PbBr₂ (0.1 M, TCI) in anhydrous N,N-dimethylformamide (Sigma-Aldrich) and dimethyl sulfoxide (DMSO, Sigma-Aldrich) (volume ratio = 9:1). The solution was added to the mixed perovskite precursor after 4 h stirring at room temperature. The perovskite solution was spin-coated onto the substrates in a two-step program at 2000 and 5000 rpm for 10 and 30 s, respectively. During the second step, 300 µL of chlorobenzene (Sigma-Aldrich) was poured on the rotating substrate 17 s prior to the end of the program. The as-deposited perovskite films were further annealed on a hotplate at 100 °C for 30 min in a nitrogen-filled glovebox.

### Inorganic electron transport material, particularly for mixed cation PSCs.
in acetonitrile] was spin-coated onto the perovskite at 2000 rpm. The semiconductors were exposed to air overnight for O2 doping of the spiro-OMeTAD. The devices were completed with a ~80 nm thick gold contact layer deposited on top of the spiro-OMeTAD via thermal evaporation at a base pressure of ~10−5 Torr.

2.3. Material Characterization. The composition of the SnO2 films was examined by X-ray photoelectron spectroscopy (XPS) (K-Alpha, Thermo Fisher Scientific Inc.), and by Rutherford back-scattering spectrometry (RBS) combined with elastic recoil detection (ERD) (2 MV Tandetron, High Voltage Engineering Europe). RBS/ERD measurements were carried out by Detect99. The crystal structures of the SnO2 and the perovskite films were analyzed using X-ray diffraction (XRD, PANalytical X’Pert PRO MRD). Optical properties, that is, refractive indices n and k, absorption coefficient α, transmission, and reflection, of SnO2 were determined by SE (NIR Ellipsometer M2000, J.A. Woollam Co.) and UV–vis–NIR spectroscopy (Agilent Cary 5000). A Taue–Lorentz oscillator in combination with a Drude oscillator is adopted in the modeling. The SnO2 layers deposited on c-Si wafers coated with a ~450 nm SiO2 layer were characterized by Hall measurements in a van der Pauw configuration (ECOPA HMS-330).

Ultraviolet photoelectron spectroscopy (UPS) measurements were performed in a multichamber VG EscaLab II system (Thermo Fisher Scientific Inc.) with a base pressure of ~10−10 Pa, using He I radiation (21.2 eV) generated in a differentially pumped discharge lamp. A specially designed sample transport unit was used to transfer the perovskite samples from the glovebox to the UPS analysis chamber, thereby preventing possible surface modification due to air exposure. The SnO2 samples, however, were exposed to air for ~5 min after being taken out from the ALD reactor.

Steady-state and time-resolved photoluminescence (TRPL) measurements were performed using an in-house built system. A 32 nm continuous-wave laser was used for the steady-state PL measurements, while a 635 nm pulsed laser operating at 5 MHz was used for the TRPL measurements. The laser beam entered the samples from the glass side.

Atomic force microscopy (AFM, Veeco Dimension 3100), scanning electron microscopy (SEM, FEI MK2 Helios Nanolab 600), and transmission electron microscopy (TEM) were employed to check the morphology of the layers. For TEM top-view imaging, SnO2 films were deposited on TEM windows consisting of a SiN membrane coated with a 5 nm thick atomic-layer-deposited SiO2 layer. A cross-sectional lamella of the PSC was prepared using a focused ion beam (FIB) lift-out technique. To protect the top surface layer, a cross-sectional lamella of the PSC was prepared using a focused ion beam (FIB) lift-out technique. To protect the top surface layer.

3. RESULTS AND DISCUSSION

3.1. Material Characterization of SnO2. 3.1.1. Chemical Composition. To determine the bonding states of the SnO2 films, XPS analysis was carried out. Figure 1 shows the XPS spectra for ~30 nm thick films of 50 and 200 °C. XPS spectra for all the films deposited at 50, 100, 150, and 200 °C are shown in Figure S3. The surface of the films was sputtered by Ar ions to remove adventitious carbon. The Sn 3d3/2 peak at 495.6 eV and the Sn 3d5/2 peak at 487.0 eV, as well as the O 1s peak at 530.8 eV are assigned to SnO2.56,57 Because the binding energies of the Sn 3d peaks for Sn2+ (SnO) are only ~0.7 eV lower with respect to those for Sn4+ (SnO2), the VB spectra are recorded to check the presence of SnO in the film (see Figure S4a).56,57 The Sn 5s peak located at 2.5–3 eV, which is the characteristic peak for SnO,56 is not observed in the VB spectra for the films deposited at all temperatures. The deconvoluted O 1s peak at 532.5 eV is associated with hydroxyl oxygen (OH) species.57 C and N contamination is also present in the film deposited at these temperatures, which can be attributed to an incomplete removal of ligands. The concentration of OH groups and of C and N contamination decreases with the increase in deposition temperature (Table 1 and Figure S3). No contamination is detected for the 200 °C film (see Figure S4b,c for the XPS survey scans).

RBS and ERD were carried out to determine the chemical composition of the films. The results are summarized in Table 1. They reveal that the film deposited at 50 °C contains a remarkably high H fraction of 20 at. %. As previously concluded from the XPS results (Figure 1), hydrogen probably mainly stems from the OH groups bonded to Sn and C. The H concentration decreases upon increasing the deposition temperature. Neither C nor N is detected by RBS. The O/Sn ratio decreases from 2.48 at 50 °C to 2.10 at 200 °C. However, it should be pointed out that the O content is calculated based on all the bonding configurations including O–H rather than only Sn–O bonding. The mass density increases with temperature. A compact film with a high mass density of 6.1 g/cm3 is obtained at 200 °C, approaching the mass density of 6.9–7.0 g/cm3 for crystalline SnO2.9,45,58 The increase in the refractive index n shown in Table 1 is consistent with this increase in density.

3.1.2. Electrical Properties. Electrical properties are of key importance for SnO2 as an electron transport material. Consequently, carrier density Nc, Hall mobility μH, and resistivity ρ of the SnO2 films have been determined from Hall measurements. The data are summarized in Table 2. The film deposited at 50 °C was not measurable because of a too high electrical resistivity. SnO2 films with a high electrical resistivity which cannot be measured by Hall measurement have been reported in the literature.45,47,48 The n-type conductivity is significantly improved at higher deposition temperatures of 150 and 200 °C. It is notable that primarily, the mobility is significantly enhanced when increasing the
deposition temperature from 150 to 200 °C, probably because of an enhanced mass density and thus an enhanced electrical continuity in the lateral direction at a higher deposition temperature (see enhanced mass density in Table 1), in combination with reduced impurity levels as confirmed by XPS analysis (Table 1 and Figure S3). The mobility reported in this work is significantly higher compared to that previously reported for atomic-layer-deposited SnO2 films deposited at a similar temperature, and is comparable to that of films deposited at a higher temperature of 250 °C containing a significant crystalline fraction. Regarding the origin of the n-type conductivity, density functional theory calculations have suggested that both oxygen vacancies (Vo) and Sn interstitials (Sni) in the lattice structure could act as shallow donors. Also, hydrogen atoms incorporated on substitutional oxygen sites were suggested to form shallow donors for the n-type conductivity of SnO2. In the present work, we believe both oxygen vacancies and H shallow dopants contribute to the n-type conductivity of atomic-layer-deposited SnO2. Despite a much higher H concentration measured for the 50 °C SnO2 with respect to the 200 °C SnO2 (Table 1), H atoms are primarily present as O−H and C−H bonds, therefore they are inactive for doping.

### 3.1.3. Structural and Morphological Properties.

To obtain information on the crystallinity of SnO2 deposited at different deposition temperatures, the films were evaluated by grazing-incidence XRD. Figure 2 shows the XRD patterns of the SnO2 deposited on ITO glass at 50 and 200 °C. The 50 °C SnO2 is amorphous, while the film deposited at 200 °C exhibits SnO2 crystalline peaks of (110) and (200) at 26.6° and 38.3°.

### Table 1. Mass Density and Relative Elemental Concentration Obtained from RBS/ERD and XPS Measurements for SnO2 Films Deposited at Different Substrate Temperatures

<table>
<thead>
<tr>
<th>temp. [°C]</th>
<th>thickness [nm]</th>
<th>C [at. %]</th>
<th>O [at. %]</th>
<th>Sn [at. %]</th>
<th>H [10¹⁵ at./cm²]</th>
<th>O/Sn</th>
<th>C [at. %]</th>
<th>N [at. %]</th>
</tr>
</thead>
<tbody>
<tr>
<td>50</td>
<td>260 ± 0.6</td>
<td>6 ± 0.4</td>
<td>6 ± 0.6</td>
<td>2 ± 0.8</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>100</td>
<td>295 ± 0.4</td>
<td>5 ± 0.5</td>
<td>5 ± 0.5</td>
<td>1 ± 0.4</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>150</td>
<td>18 ± 0.2</td>
<td>10 ± 0.2</td>
<td>10 ± 0.2</td>
<td>3 ± 0.1</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>200</td>
<td>33 ± 0.5</td>
<td>8 ± 0.2</td>
<td>8 ± 0.2</td>
<td>4 ± 0.1</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

*Film thicknesses and refractive indices from SE measurements are also included. The relative errors in atomic percentages of Sn, O, and H measured by RBS/ERD are 2, 4, and 7%, respectively. The standard deviations for C and N contamination measured by XPS are calculated based on 3–5 samples for each temperature. Negligible.

### Table 2. Electrical Properties of SnO2 Films Deposited at Various Substrate Temperatures as Obtained from Hall Measurements

<table>
<thead>
<tr>
<th>temp. [°C]</th>
<th>thickness [nm]</th>
<th>carrier density N_e [×10¹⁹ cm⁻³]</th>
<th>mobility μ_H [cm²/V s]</th>
<th>resistivity ρ [mΩ cm]</th>
</tr>
</thead>
<tbody>
<tr>
<td>50</td>
<td>33 ± 0.6</td>
<td>6.5 ± 1.0</td>
<td>9 ± 1</td>
<td>10.7 ± 0.3</td>
</tr>
<tr>
<td>100</td>
<td>30 ± 0.4</td>
<td>6.5 ± 1.0</td>
<td>9 ± 1</td>
<td>10.7 ± 0.3</td>
</tr>
<tr>
<td>150</td>
<td>32 ± 0.1</td>
<td>6.5 ± 1.0</td>
<td>9 ± 1</td>
<td>1.8 ± 0.03</td>
</tr>
<tr>
<td>200</td>
<td>33 ± 0.5</td>
<td>8.4 ± 0.2</td>
<td>35 ± 1</td>
<td>2.1 ± 0.05</td>
</tr>
</tbody>
</table>

*The layers deposited at 50 and 100 °C are not measurable because of a too large electrical resistivity. Five samples were measured in each series, and standard deviations are included.
respectively. The broadening of the (110) peak can be attributed to a very small size of the crystallites, which was further examined by TEM. The low intensity of these two peaks can be explained by the low crystalline fraction, as well as the small film thickness of only ~30 nm. A similar crystallinity is found for the SnO₂ films deposited at 200 °C on c-Si wafer substrates (Figure S5). The XRD results are in line with those reported for SnO₂ films deposited by ALD at comparable deposition temperatures using the TDMASn precursor, though different oxidation sources of hydrogen peroxide, water, and ozone were used in their work.

TEM and AFM have been adopted to infer the morphology and grain size of the films. Figure 3 displays the top-view TEM images. No crystallites are identified for the 30 nm thick film deposited at 50 °C (Figure 3a,e). The 15 and 30 nm thick films grown on polished c-Si exhibit a small root-mean-square (rms) roughness of only 0.23 and 0.33 nm, respectively, as measured by AFM (Figure S6). In contrast, nanocrystallites of 4–5 nm in the lateral direction emerge from the amorphous matrix for the 15 nm thick film deposited at 200 °C (the dark phase in Figure 3b, as is also indicated by the dashed line in Figure 3f). These nanocrystallites result in a larger rms of 0.51 nm (Figure S6). Upon increasing the film thickness from 15 to 30 nm at 200 °C, larger crystallites of various sizes (e.g. ~25 nm in Figure 3g and 7–8 nm in Figure 3h) with a higher site density are obtained (Figure 3c), together with a significantly enhanced rms roughness of 1.54 nm. The electron diffraction pattern shown in Figure 3d indicates that the matrix of the film deposited at 200 °C remains amorphous.

3.1.4. Optical Properties. Optical properties of the films have been characterized by SE and UV−Vis−NIR spectroscopy. Figure 4a compares the absorption coefficients extracted from SE measurements for the SnO₂ films, with Figure 4b showing the Tauc band gap values assuming a direct band gap of SnO₂.45,51,62 The optical band gap decreases from 4.25 to 3.25 eV with an increase in the deposition temperature from 50 to 200 °C. Similarly, large optical band gaps in the range of 4.0–4.4 eV have been reported for amorphous SnO₂ deposited by ALD below 100 °C, which decreased to slightly below 3 eV upon increasing the deposition temperature to 200 °C, corresponding to an enhanced crystallinity.45–47 Refractive index (n) and extinction coefficient (k) as a function of photon energy hv for SnO₂ films deposited on polished c-Si wafers.
eV are measured for the 50 °C SnO₂. Comparable values are measured for the SnO₂ film grown on an ITO glass substrate (Figure S8). A CBM of 3.70 eV is calculated using CBM = IE − E_g, where E_g is the Tauc band gap of 4.25 eV. For the 200 °C SnO₂, a WF of 4.2 eV, a shallower VB edge of 7.57 eV is found resulting in a deeper CBM of 4.32 eV using the Tauc E_g of 3.25 eV. A similar ~0.5 eV downward shift of CBM has been reported upon crystallization of as-deposited amorphous SnO₂ prepared at 118 °C.48 The WF values obtained in this work fall in the range of 4.1−4.6 eV previously reported for SnO₂ films fabricated by ALD24,25,50 and by solution processing.68 The downward shift of CBM and upward shift of VBM for the 200 °C SnO₂ could have a detrimental impact on the quasi-Fermi splitting in the perovskite, and on the hole blocking ability,33,48 which could result in a lower V_oc of the PSCs.

For both the 50 and 200 °C SnO₂, no obvious gap states are visible in the VB spectra of the SnO₂ layers (Figure Sb). Note that the UPS VB spectra are similar to those measured by XPS (Figure S4a), and the VBM values extracted from the two different characterization methods are also fairly comparable.

Figure Sf,g depicts the energy-level diagrams of the devices. A notable 0.69 eV CBM mismatch is present at the interface between the 50 °C SnO₂ and the perovskite, whereas an excellent CBM alignment is demonstrated for the 200 °C SnO₂. Simulated band bending diagrams for the devices in dark equilibrium are provided in Figure S14. Surprisingly, this energy-level mismatch does not cause a severe deterioration in the initial cell performance, as will be shown in the next section. In addition, because of the SnO₂ thickness of 15 nm, tunneling of the electrons is unlikely to occur. Therefore, a reasonable scenario is that some shallow defects could play a role in assisting the electron extraction across the SnO₂/perovskite interface. At the other side of the band gap,
sufficiently higher energy barriers at the VBM to block hole transport are demonstrated for both types of SnO₂.

As a comparison of electron extraction at the interfaces between the perovskite and the two different SnO₂ ETLs, steady-state and TRPL measurements are shown in Figure 6a.

The perovskite absorbers exhibit emission peaks centered at around 780 nm, corresponding to a band gap of 1.59 eV. This band gap value is confirmed by Fourier transform photocurrent spectroscopy (FTPS) as shown in Figure S9 (1.57 eV). Asymmetric PL peaks are recorded for the bare perovskites on spectroscopy (FTPS) as shown in Figure S9 (1.57 eV). Asymmetric PL peaks are recorded for the bare perovskites on spectroscopy (FTPS) as shown in Figure S9 (1.57 eV). Asymmetric PL peaks are recorded for the bare perovskites on spectroscopy (FTPS) as shown in Figure S9 (1.57 eV). Asymmetric PL peaks are recorded for the bare perovskites on spectroscopy (FTPS) as shown in Figure S9 (1.57 eV).

Consider the PL quenching and the faster decay of the carrier lifetime are indications of a more efficient charge extraction from the perovskite to the charge transport layer(s), considering comparable bulk perovskites.55,54,65 However, it should be pointed out that the PL signal is influenced by both interface recombination and charge extraction. It is not straightforward to distinguish both contributions to the PL signal. Considering that the 200 °C SnO₂ possesses a much higher electron mobility and a much better conduction band match with the perovskite, we believe that the PL quenching is indicative of a faster charge extraction at the 200 °C SnO₂/perovskite interface.

3.3. SnO₂ as an ETL in PSCs. To correlate material properties of SnO₂ with the performance of PSCs, SnO₂ films deposited at 50 and 200 °C have been implemented as ETLs in planar Cs₀.⁰₅(MA₀.¹₇FA₀.₈₃)₀.₉₅Pb(I₂.₇Br₀.₃) PSCs. Figure 7a depicts a schematic diagram of the cell design. An SEM cross-sectional image of the complete cell using SnO₂ deposited at 50 °C as the ETL. TEM image displaying the ITO/SnO₂/perovskite interfaces. (d) Top-view SEM image of the perovskite grains grown on the 50 °C SnO₂. The gray phases are PbI₂.
characterized by TEM and EDX, whereas its presence between atomic-layer-deposited SnO2 and MAPbI3 layers was reported in the literature.50

The performance of the PSCs has been characterized via J−V measurements under AM1.5G illumination. Figure 9 shows plots of the reverse J−V scans of the best performing PSCs. Comparable PCEs of 17.5 and 17.8% have been achieved for the champion cells using 50 and 200 °C SnO2. Statistics on PCE, Voc, Jsc, and FF of the devices are also present in Figure 9. A total number of 35 and 16 PSCs from three batches using 50 and 200 °C SnO2 ETLs have been tested for the statistics, respectively. We notice a scattering of the J−V data. As the atomic-layer-deposited SnO2 is deposited under a well-controlled condition with excellent reproducibility, the data fluctuation is mainly ascribed to the variation on the nucleation and growth of the perovskite on the SnO2. The average cell characteristics from backward J−V scans of the top 10 devices of each group are listed in Table 3. The cells with 50 °C SnO2 perform on average slightly better in Voc but slightly worse in $F_F$. The inset shows the extracted PV characteristics. Statistics on PCE, Voc, Jsc, and FF extracted from reverse J−V scans are also included.

Figure 9. Reverse J−V scans (scan rate: 200 mV/s, stepwise: 10 mV) for the champion PSCs using 15 nm thick atomic-layer-deposited SnO2 films deposited at 50 or 200 °C as the ETLs. The inset shows the extracted PV characteristics. Statistics on PCE, Voc, Jsc, and FF extracted from reverse J−V scans are also included.

Table 3. Average J−V Characteristics with Standard Deviations from the Top 10 Devices Using Either 50 or 200 °C SnO2

<table>
<thead>
<tr>
<th>sample</th>
<th>Jsc [mA/cm²]</th>
<th>Voc [mV]</th>
<th>FF [%]</th>
<th>PCE [%]</th>
</tr>
</thead>
<tbody>
<tr>
<td>50 °C SnO2</td>
<td>21.4 ± 0.6</td>
<td>1086 ± 25</td>
<td>70 ± 2</td>
<td>16.2 ± 0.7</td>
</tr>
<tr>
<td>200 °C SnO2</td>
<td>21.3 ± 0.9</td>
<td>1061 ± 11</td>
<td>71 ± 4</td>
<td>16.1 ± 1</td>
</tr>
</tbody>
</table>
FF with respect to the cells adopting the 200 °C SnO2. The lower FF values are mainly attributed to a much higher series resistance for the 50 °C SnO2, as indicated by the Hall measurements shown in Table 2. The higher Voc could be explained by the upward shift of CBM and downward shift of VBM for the 50 °C SnO2 (Figure 5), which could lead to a broader quasi-Fermi splitting in the perovskite. In addition, it was found by Lee et al. that residual TDMASn precursors can passivate SnO2 deposited at 100 °C by ALD.54 In the present work, the SnO2 film deposited at 50 °C contains a significant amount of C and N impurities as well as OH groups from an incomplete reaction of the precursors as confirmed by XPS spectra (Figure S3). The self-passivation effect from the residual TDMASn precursors might also exist in the 50 °C SnO2. This passivation could reduce recombination at the SnO2/perovskite interface, which is consistent with the larger Voc for the devices using the 50 °C SnO2. Furthermore, this speculation agrees with the higher PL signal and the longer TRPL lifetime for the perovskite grown on the 50 °C SnO2 (Figure 6).

The J–V characteristics of our devices are comparable to those of state-of-the-art planar n–i–p PSCs based on atomic-layer-deposited SnO2 ETLs. For instance, Lee et al. reported similar J–V parameters of 22.59 ± 0.15 mA/cm2, 1.07 ± 0.04 V, 0.73 ± 0.03, and (17.75 ± 0.62)% using a cell configuration of FTO/SnO2/FAMAPb(I,Br)3/PTAA/Au.54 By applying a compact TiO2 layer underneath the SnO2 forming a bilayer ETL, the cell performance was further improved to 22.68 ± 0.30 mA/cm2, 1.13 ± 0.01 V, 0.78 ± 0.01, and 19.83 ± 0.02%. The enhancement was mainly attributed to a better hole blocking ability, thanks to the underlying compact TiO2 layer. Wang et al. reported 21.17 mA/cm2, 1.074 V, 75.48, and 17.16% for their PSCs using a configuration of MAPbI3/spiro-OMeTAD/Au, with the SnO2 deposited at 100 °C by plasma-enhanced ALD. Inserting a C60 self-assembled monolayer passivation at the SnO2/perovskite interface improved the PCE to 18.21% because of increased Voc and FF.40 These works point out that there is still room for performance gain in the present work via optimization of the SnO2/perovskite interface.

Hysteresis is present between the forward and reverse J–V scans for both types of PSCs, as shown in Figure S13 and Table S1. Halide ion migration and unbalanced charge extraction are generally believed to be the most probable reasons among several potential causes for hysteresis in J–V characteristics.3,66–68 An imperfect interfacial structure could cause a charge accumulation at the interface, which consequently leads to hysteresis in the J–V scans.25,66 Hysteresis is commonly seen in other works applying SnO2 as ETLs prepared by either ALD49–51 or solution process methods in planar PSCs.31,68,69 It was reported that a low electron mobility of SnO2 prepared by ALD at 100 °C is partly responsible for the hysteresis of PSCs.34 However, in our study, the hysteresis is not reduced by applying the 200 °C SnO2 with a high electron mobility of 36.0 cm2/V s in the PSCs. This observation leads to a hypothesis that hysteresis in the present work can be rather ascribed to halide ion migration near the interface and interface defects instead of bulk properties of both SnO2 and perovskite. Hysteresis is shown in the literature to be quantitatively suppressed by introducing an interfacial defect passivation layer of, for example, fullerene C60 layer,31,49,53 or [6,6]-phenyl C60 (or C70) butyric acid methyl ester (PCBM) layer,68 or amorphous SnOCl2.53 In the present work, with the insertion of a PCBM layer (purchased from Nano-C) by spin-coating between SnO2 and perovskite, the hysteresis indeed was significantly reduced (Figure S13a,b). Electron extraction could be promoted at this interface, thereby reducing the hysteresis.

In the literature, a so-called stabilized efficiency is typically measured under continuous AM1.5G illumination at the maximum power point (MPP) with a duration in the range of 150–600 s. In the current work, we extended the test duration to 16 h to check the light stability of the PSCs. Markedly, the compact SnO2 deposited at 200 °C results in a reasonably stable cell performance over 16 h measured in a nitrogen filled glovebox, as depicted in Figure 10. Interestingly, a rise in PCE is observed during the first hour corresponding to increase in both voltage (Voc) and photocurrent (Jsc) (not shown). Increase in PCE during the first 400 h under MPP tracking is reported in the literature. In that work, an inverted p–i–n architecture with Cs0.17FA0.83Pb(Br0.17I0.83)3 perovskite grown on a NiOx film is employed. They ascribed the PCE rise to the improvement of the NiOx/perovskite interface or the increased perovskite crystallinity.53 In the present case, we tend to believe a potential improvement of the SnO2/perovskite interface under illumination could be responsible for the rise in PCE. In contrast, the PCE of the counterpart cell using the 50 °C SnO2 decreases by approximately 50% after 16 h because of a decrease in both photocurrent and voltage. This phenomenon was reproduced in other identical devices. However, the decrease in PCE is significantly reduced when applying a PCBM interfacial layer between the 50 °C SnO2 and the perovskite. These observations lead to a conclusion that the 50 °C SnO2/perovskite interface suffers from a light instability issue. We speculate the potential reasons for the degradation including photoactivated defects and band alignment variation upon illumination, which lead to charge accumulation and recombination at the ETL/perovskite interface. The 50 °C SnO2 exhibits conduction band offset and lower charge mobility with respect to the 200 °C SnO2, as the latter owns an excellent conduction band alignment with the perovskite and a much higher electron mobility. The PCBM interlayer could result in a more favorable band alignment for faster charge extraction and a reduced interfacial recombination upon illumination, which explain the gentle degradation under light soaking. Pérez-del-Rey et al. reported similar findings by inserting a thin (~10 nm) interlayer of C60 at the TiO2/...
Assisted atomic layer deposition. The SnO₂ film is prepared in a temperature range of 50–200 °C. Comparable initial efficiency decreases by approximately 50% when keeping the ETL thin at 15 nm. Comparable initial efficiencies are demonstrated for the PSCs using either 50 or 200 °C SnO₂ as the ETL. The electrically conductive SnO₂ with a high electron mobility is employed. The introduction of a PCBM interlayer is present in the PSCs regardless of whether resistive or conductive SnO₂ is employed. The excellent conduction band alignment is demonstrated between the 200 °C SnO₂ and the perovskite. However, electron transport at this interface is not critical for both initial performance and long-term light stability. Further study of the mechanisms for stability under a longer light soaking is thus required.

4. CONCLUSIONS

In summary, bulk (chemical, structural, electrical, and optical) properties and interfacial properties of atomic-layer-deposited SnO₂ as an electron transport material for PSCs have been studied. Highly transparent amorphous SnO₂ films are prepared in a temperature range of 50–200 °C by plasma-assisted atomic layer deposition. The SnO₂ films possess deep VBs for hole blocking at the SnO₂/perovskite interface. An excellent conduction band alignment is demonstrated between the 200 °C SnO₂ and the perovskite. In contrast, a conduction band offset is present between the 50 °C SnO₂ and the perovskite. However, electron transport at this interface is not blocked by this energy offset when keeping the ETL thin at 15 nm. Comparable initial efficiencies are demonstrated for the PSCs using either 50 or 200 °C SnO₂ as the ETL. The electrically conductive SnO₂ with a high electron mobility deposited at 200 °C results in on average a slightly higher FF but lower Voc for the PSCs with respect to those using the resistive SnO₂ deposited at 50 °C. Current–voltage hysteresis is present in the PSCs regardless of whether resistive or conductive SnO₂ is employed. The introduction of a PCBM interfacial layer between the SnO₂ and the perovskite significantly reduces this hysteresis. Regarding light stability, the SnO₂ deposited at 200 °C contributes to a more stable cell performance over 16 h under continuous AM1.5G illumination. In contrast, the efficiency decreases by approximately 50% for the counterpart device using the 50 °C SnO₂. We believe the SnO₂/perovskite interface is critical for both initial performance and long-term light stability. Further investigation of defects and chemical bonding at the SnO₂/perovskite interface and their role in device performance is therefore of key importance to promote the application of atomic-layer-deposited SnO₂ as the ETL in planar PSCs.

ASSOCIATED CONTENT

Supporting Information

The Supporting Information is available free of charge on the ACS Publications website at DOI: 10.1021/acsami.8b09515.

Schematics for the ALD reactor and the ALD recipe; XPS, XRD spectra, and AFM images for the SnO₂ films deposited at 50, 100, 150, and 200 °C; TEM images for the SnO₂ films deposited at 50 and 200 °C; transmission and reflection spectra for the SnO₂ films deposited on ITO glass substrates; UPS spectra for the SnO₂ films deposited on c-Si (100) wafers and on ITO glass substrates; FTPS, XPS, XRD spectra, and SEM images for the perovskites grown on the SnO₂ films; TEM cross-sectional image of the complete perovskite cell with associated EDX individual elemental maps; solar cell characteristics extracted from reverse and forward scans at scan rates of 20, 200, and 2000 mV/s for the PSCs using SnO₂ and SnO₂/PCBM bilayer as the ETL; procedures for simulations using a solar cell capacitance simulator in one-dimensional (SCAPS-1D) software; and simulated band bending diagrams for the PSCs (PDF).

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Notes

The authors declare no competing financial interest.

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MAPbI₃ interface. Interfacial properties including leakage current, interfacial recombination, and band alignment are improved after a bias/ultraviolet light activation with the presence of this interlayer. Nevertheless, in the current work, the exact mechanisms for the PCE degradation are not fully understood. Further study of the mechanisms for stability under a longer light soaking is thus required.


